HEF4557B

1-to-64 bit variable length shift register Rev. 6 — 18 November 2011

Product data sheet

1. **General description**

The HEF4557B is a static clocked serial shift register whose length may be programmed to be any number of bits between 1 and 64. The number of bits selected is equal to the sum of the subscripts of the enabled length control inputs (L1, L2, L4, L8, L16, and L32) plus one. Serial data may be selected from the DA or DB data inputs with the A/B select input. This feature is useful for recirculation purposes. Information on DA or DB is shifted into the first register position and all the data in the register is shifted one position to the right on the LOW to HIGH transition of CP0 while CP1 is LOW or on the HIGH to LOW transition of CP1 while CP0 is HIGH. A HIGH on master reset (MR) resets the register and forces Q to LOW and Q to HIGH, independent of the other inputs.

It operates over a recommended V_{DD} power supply range of 3 V to 15 V referenced to V_{SS} (usually ground). Unused inputs must be connected to V_{DD}, V_{SS}, or another input.

Features and benefits 2.

- Fully static operation
- 5 V, 10 V, and 15 V parametric ratings
- Standardized symmetrical output characteristics
- Specified from -40 °C to +85 °C
- Complies with JEDEC standard JESD 13-B

3. Ordering information

Table 1. **Ordering information**

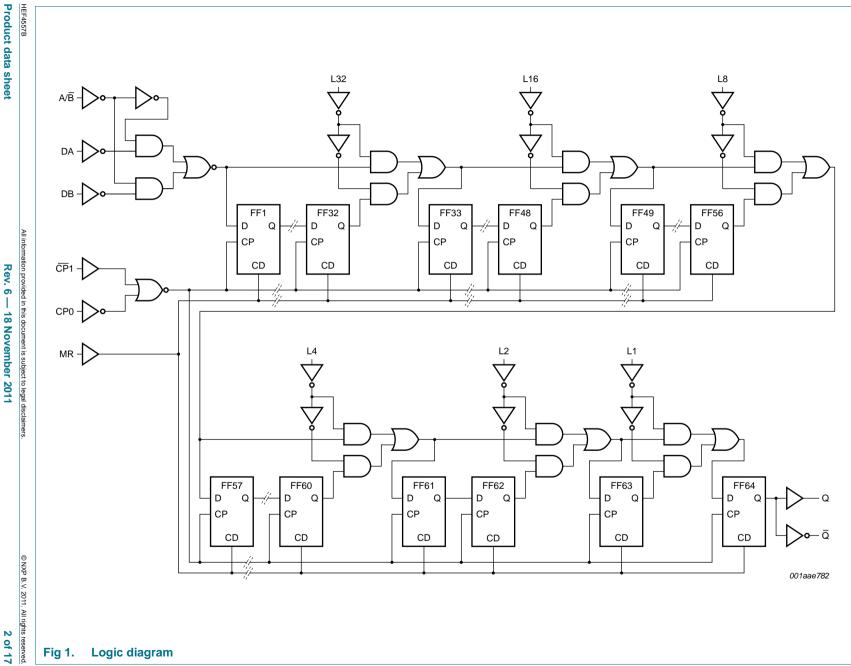
All types operate from −40 °C to +85 °C

| Type number | r Package | | | | | | | |
|-------------|-----------|--|----------|--|--|--|--|--|
| | Name | Description | Version | | | | | |
| HEF4557BP | DIP16 | plastic dual in-line package; 16 leads (300 mil) | SOT38-4 | | | | | |
| HEF4557BT | SO16 | plastic small outline package; 16 leads; body width 3.9 mm | SOT109-1 | | | | | |

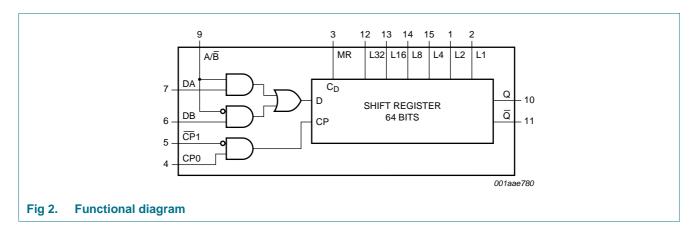


1-to-64 bit variable length shift register

Functional diagram

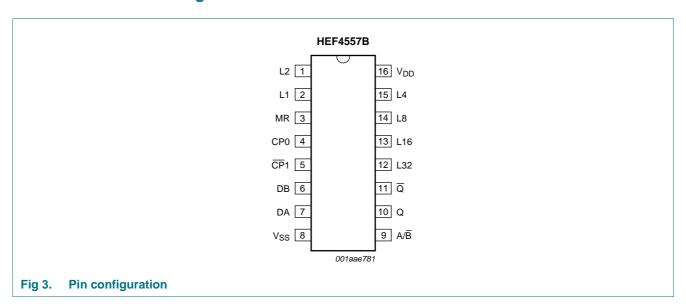


1-to-64 bit variable length shift register



5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2. Pin description table

| · · | | |
|--------------------------|----------------------|---------------------------|
| Symbol | Pin | Description |
| L1, L2, L4, L8, L16, L32 | 2, 1, 15, 14, 13, 12 | bit-length control input |
| MR | 3 | asynchronous master reset |
| CP0 | 4 | clock input |
| CP1 | 5 | clock input |
| DA, DB | 7, 6 | data input |
| V _{SS} | 8 | ground (0 V) |
| A/\overline{B} | 9 | select data input |

1-to-64 bit variable length shift register

Table 2. Pin description table ... continued

| Symbol | Pin | Description |
|----------|-----|-------------------------------|
| Q | 10 | buffered output |
| Q | 11 | complementary buffered output |
| V_{DD} | 16 | supply voltage |

6. Functional description

Table 3. Function table[1]

| Inputs | Output | | | | | |
|--------|--------|----------------|-------|----------|----------|----------------|
| MR | A/B | DA | DB | CP0 | CP1 | Q |
| L | L | D_1 | D_2 | ↑ | L | D_2 |
| L | Н | D ₁ | D_2 | ↑ | L | D ₁ |
| L | L | D ₁ | D_2 | Н | \ | D_2 |
| L | Н | D ₁ | D_2 | Н | \ | D ₁ |
| Н | X | X | X | X | X | L |

^[1] The moment D_n appears at Q depends on the bit-length shown in Table 4; H = HIGH voltage level; L = LOW voltag

Table 4. Bit-length select function table

| L32 | L16 | L8 | L4 | L2 | L1 | Register length |
|-----|-----|--------------|-------------------|--------------------|------------------|-----------------|
| L | L | L | L | L | L | 1-bit |
| L | L | L | L | L | Н | 2-bits |
| L | L | L | L | Н | L | 3-bits |
| L | L | L | L | Н | Н | 4-bits |
| L | L | L | Н | L | L | 5-bits |
| L | L | L | Н | L | Н | 6-bits |
| L | L | L | Н | Н | L | 7-bits |
| L | L | L | Н | Н | Н | 8-bits |
| | | L1 to L16 co | ntinue to increme | ent in a binary co | ount with L32 LO | N |
| L | Н | Н | Н | Н | Н | 32-bits |
| Н | L | L | L | L | L | 33-bits |
| Н | L | L | L | L | Н | 34-bits |
| | | L1 to L16 co | ntinue to increme | ent in a binary co | unt with L32 HIG | Н |
| Н | Н | Н | Н | L | L | 61-bits |
| Н | Н | Н | Н | L | Н | 62-bits |
| Н | Н | Н | Н | Н | L | 63-bits |
| Н | Н | Н | Н | Н | Н | 64-bits |
| | | | | | | |

1-to-64 bit variable length shift register

7. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|------------------|-------------------------|---|--------------|----------------|------|
| V_{DD} | supply voltage | | -0.5 | +18 | V |
| I _{IK} | input clamping current | $V_I < -0.5 \text{ V or } V_I > V_{DD} + 0.5 \text{ V}$ | - | ±10 | mA |
| V_{I} | input voltage | | -0.5 | $V_{DD} + 0.5$ | V |
| lok | output clamping current | $V_O < -0.5 \text{ V or } V_O > V_{DD} + 0.5 \text{ V}$ | - | ±10 | mA |
| I _{I/O} | input/output current | | - | ±10 | mA |
| I_{DD} | supply current | | - | 50 | mA |
| T _{stg} | storage temperature | | -65 | +150 | °C |
| T _{amb} | ambient temperature | | -40 | +85 | °C |
| P _{tot} | total power dissipation | DIP16 package | <u>[1]</u> _ | 750 | mW |
| | | SO16 package | [2] _ | 500 | mW |
| Р | power dissipation | per output | - | 100 | mW |

^[1] For DIP16 package: P_{tot} derates linearly with 12 mW/K above 70 °C.

8. Recommended operating conditions

Table 6. Recommended operating conditions

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|---------------------|-------------------------------------|------------------------|-----|-----|----------|------|
| V_{DD} | supply voltage | | 3 | - | 15 | V |
| VI | input voltage | | 0 | - | V_{DD} | V |
| T _{amb} | ambient temperature | in free air | -40 | - | +85 | °C |
| $\Delta t/\Delta V$ | input transition rise and fall rate | $V_{DD} = 5 V$ | - | - | 3.75 | μs/V |
| | | V _{DD} = 10 V | - | - | 0.5 | μs/V |
| | | V _{DD} = 15 V | - | - | 0.08 | μs/V |

^[2] For SO16 package: Ptot derates linearly with 8 mW/K above 70 °C.

1-to-64 bit variable length shift register

9. Static characteristics

Table 7. Static characteristics

 $V_{SS} = 0$ V; $V_I = V_{SS}$ or V_{DD} unless otherwise specified.

| Symbol | Parameter | Conditions | V_{DD} | T _{amb} = | –40 °C | T _{amb} = 25 °C | | T _{amb} = 85 °C | | Unit |
|-----------------|------------------------------|-------------------------|----------|--------------------|--------|--------------------------|-------|--------------------------|-------|------|
| | | | | Min | Max | Min | Max | Min | Max | |
| V_{IH} | HIGH-level input voltage | $ I_O < 1 \mu A$ | 5 V | 3.5 | - | 3.5 | - | 3.5 | - | V |
| | | | 10 V | 7.0 | - | 7.0 | - | 7.0 | - | V |
| | | | 15 V | 11.0 | - | 11.0 | - | 11.0 | - | V |
| V _{IL} | LOW-level input voltage | $ I_O < 1 \mu A$ | 5 V | - | 1.5 | - | 1.5 | - | 1.5 | V |
| | | | 10 V | - | 3.0 | - | 3.0 | - | 3.0 | V |
| | | | 15 V | - | 4.0 | - | 4.0 | - | 4.0 | V |
| V_{OH} | OH HIGH-level output voltage | $ I_O < 1 \mu A$ | 5 V | 4.95 | - | 4.95 | - | 4.95 | - | V |
| | | | 10 V | 9.95 | - | 9.95 | - | 9.95 | - | V |
| | | | 15 V | 14.95 | - | 14.95 | - | 14.95 | - | V |
| V_{OL} | LOW-level output voltage | $ I_O < 1 \mu A$ | 5 V | - | 0.05 | - | 0.05 | - | 0.05 | V |
| | | | 10 V | - | 0.05 | - | 0.05 | - | 0.05 | V |
| | | | 15 V | - | 0.05 | - | 0.05 | - | 0.05 | V |
| I _{OH} | HIGH-level output current | $V_0 = 2.5 \text{ V}$ | 5 V | - | -1.7 | - | -1.4 | - | -1.1 | mA |
| | | $V_{O} = 4.6 \text{ V}$ | 5 V | - | -0.52 | - | -0.44 | - | -0.36 | mA |
| | | $V_{O} = 9.5 \ V$ | 10 V | - | -1.3 | - | -1.1 | - | -0.9 | mA |
| | | $V_0 = 13.5 \text{ V}$ | 15 V | - | -3.6 | - | -3.0 | - | -2.4 | mA |
| I_{OL} | LOW-level output current | $V_0 = 0.4 \ V$ | 5 V | 0.52 | - | 0.44 | - | 0.36 | - | mA |
| | | $V_{O} = 0.5 \ V$ | 10 V | 1.3 | - | 1.1 | - | 0.9 | - | mA |
| | | $V_0 = 1.5 \ V$ | 15 V | 3.6 | - | 3.0 | - | 2.4 | - | mA |
| II | input leakage current | | 15 V | - | ±0.3 | - | ±0.3 | - | ±1.0 | μΑ |
| I_{DD} | supply current | $I_O = 0 A$ | 5 V | - | 50 | - | 50 | - | 375 | μΑ |
| | | | 10 V | - | 100 | - | 100 | - | 750 | μΑ |
| | | | 15 V | - | 200 | - | 200 | - | 1500 | μΑ |
| C _I | input capacitance | | - | - | - | - | 7.5 | - | - | pF |

1-to-64 bit variable length shift register

10. Dynamic characteristics

Table 8. Dynamic characteristics

 $V_{SS} = 0 \text{ V; } T_{amb} = 25 \text{ °C; for test circuit see } \underline{Figure 6}$; unless otherwise specified.

| | | | | | · ' · · · · · · · · · · · · · · · · · · | | _ | | |
|---|-------------------|--|----------|------------|---|-----|------|-----|------|
| - | Parameter | Conditions | V_{DD} | | xtrapolation formula | Min | Тур | Max | Unit |
| t _{PHL} | HIGH to LOW | CP0, $\overline{CP1}$ to Q, \overline{Q} ; | 5 V | | 13 ns + (0.55 ns/pF)C _L | - | 240 | 480 | ns |
| | propagation delay | see <u>Figure 4</u> | 10 V | • | 79 ns + (0.23 ns/pF)C _L | - | 90 | 180 | ns |
| | | | 15 V | : | 57 ns + (0.16 ns/pF)C _L | - | 65 | 130 | ns |
| | | MR to Q; see Figure 4 | 5 V | 1 | 43 ns + (0.55 ns/pF)C _L | - | 170 | 340 | ns |
| | | | 10 V | | 69 ns + (0.23 ns/pF)C _L | - | 80 | 160 | ns |
| | | | 15 V | ; | 52 ns + (0.16 ns/pF)C _L | - | 60 | 120 | ns |
| t _{PLH} | LOW to HIGH | CP0, $\overline{CP1}$ to Q, \overline{Q} ; | 5 V | [1] 2 | 13 ns + $(0.55 \text{ ns/pF})C_L$ | - | 240 | 480 | ns |
| | propagation delay | see <u>Figure 4</u> | 10 V | • | 79 ns + (0.23 ns/pF)C _L | - | 90 | 180 | ns |
| | | | 15 V | : | 57 ns + (0.16 ns/pF)C _L | - | 65 | 130 | ns |
| | | MR to Q; see Figure 4 | 5 V | 1 | 13 ns + (0.55 ns/pF)C _L | - | 140 | 280 | ns |
| | | | 10 V | | 59 ns + (0.23 ns/pF)C _L | - | 70 | 140 | ns |
| | | | 15 V | | 47 ns + (0.16 ns/pF)C _L | - | 55 | 110 | ns |
| t _t | transition time | see Figure 4 | 5 V | <u>[1]</u> | 10 ns + (1.00 ns/pF)C _L | - | 60 | 120 | ns |
| | | | 10 V | | 9 ns + (0.42 ns/pF)C _L | - | 30 | 60 | ns |
| | | | 15 V | | 6 ns + (0.28 ns/pF)C _L | - | 20 | 40 | ns |
| t _{su} | set-up time | \overline{DA} , DB, $\overline{A/B}$ to CP0, | 5 V | [2] | | 360 | 180 | - | ns |
| | | $\overline{CP}1$; L1 to L32 = LOW; see $\underline{Figure 5}$ | 10 V | | | 140 | 70 | - | ns |
| | | | 15 V | | | 90 | 45 | - | ns |
| | | \overline{DA} , DB, A/ \overline{B} to CP0, $\overline{CP1}$; L32 = HIGH; | 5 V | | | +40 | -20 | - | ns |
| | | | 10 V | | | +35 | -10 | - | ns |
| | | see Figure 5 | 15 V | | | +30 | -5 | - | ns |
| t _h | hold time | \overline{DA} , DB, \overline{AB} to CP0, | 5 V | [2] | | -40 | -110 | - | ns |
| | | $\overline{CP}1$; L1 to L32 = LOW; | 10 V | | | -10 | -45 | - | ns |
| | | see Figure 5 | 15 V | | | 0 | -30 | - | ns |
| | | DA, DB, A/\overline{B} to CP0, | 5 V | | | 90 | 30 | - | ns |
| | | <u>CP</u> 1; | 10 V | | | 60 | 20 | - | ns |
| | | L1 to L32 = HIGH; see Figure 5 | 15 V | | | 50 | 15 | - | ns |
| t _W | pulse width | CP0 input LOW; | 5 V | | | 180 | 90 | - | ns |
| - • • • • • • • • • • • • • • • • • • • | F | minimum width; | 10 V | | | 60 | 30 | _ | ns |
| | | see Figure 5 | 15 V | | | 40 | 20 | - | ns |
| | | CP1 input HIGH; | 5 V | | | 180 | 90 | - | ns |
| | | minimum width; | 10 V | | | 60 | 30 | - | ns |
| | | see Figure 5 | 15 V | | | 40 | 20 | - | ns |
| | | MR input HIGH; | 5 V | | | 150 | 75 | - | ns |
| | | minimum width; | 10 V | | | 70 | 35 | - | ns |
| | | see Figure 5 | 15 V | | | 50 | 25 | | |
| | | | 10 0 | | | 50 | 20 | - | ns |

1-to-64 bit variable length shift register

 Table 8.
 Dynamic characteristics ...continued

 $V_{SS} = 0 \text{ V}$; $T_{amb} = 25 \text{ °C}$; for test circuit see <u>Figure 6</u>; unless otherwise specified.

| Symbol | Parameter | Conditions | V_{DD} | Extrapolation formula | Min | Тур | Max | Unit |
|------------------|---------------|----------------------------------|----------|-----------------------|-----|-----|-----|------|
| t _{rec} | recovery time | MR input; | 5 V | [2] | 500 | 250 | - | ns |
| | | L1 to L32 = LOW; see Figure 5 | 10 V | | 250 | 125 | - | ns |
| | | see <u>Figure 5</u> | 15 V | | 150 | 75 | - | ns |
| | | MR input; L32 = HIGH | 5 V | | 110 | 50 | - | ns |
| | | | 10 V | | 70 | 30 | - | ns |
| | | | 15 V | | 60 | 25 | - | ns |
| f _{max} | maximum | see <u>Figure 5</u> | 5 V | | 2.5 | 5 | - | MHz |
| | frequency | | 10 V | | 7 | 14 | - | MHz |
| | | | 15 V | | 10 | 20 | - | MHz |

^[1] The typical values of the propagation delay and transition times are calculated from the extrapolation formulas shown (C_L in pF).

Table 9. Interpolation table [1]

| Length | h contro | l inputs | | | | Minimum number of | Set-up, hold, and | Example: t _{rec} | |
|--------|----------|----------|----|-----|-----|-------------------|--------------------|--------------------------------|--|
| L1 | L2 | L4 | L8 | L16 | L32 | bits selected | recovery times | minimum, V _{DD} = 5 V | |
| L | L | L | L | L | L | 1 | see Table 8 | 500 ns | |
| Н | L | L | L | L | L | 2 | (interpolate in 6 | 435 ns | |
| X | Н | L | L | L | L | 3 | equal steps) | 370 ns | |
| Χ | Χ | Н | L | L | L | 5 | | 305 ns | |
| X | X | Х | Н | L | L | 9 | | 240 ns | |
| X | X | Х | Х | Н | L | 17 | | 175 ns | |
| X | X | Х | X | Х | Н | 33 | see <u>Table 8</u> | 110 ns | |

^[1] H = HIGH voltage level; L = LOW voltage level; X = don't care

Table 10. Dynamic power dissipation P_D

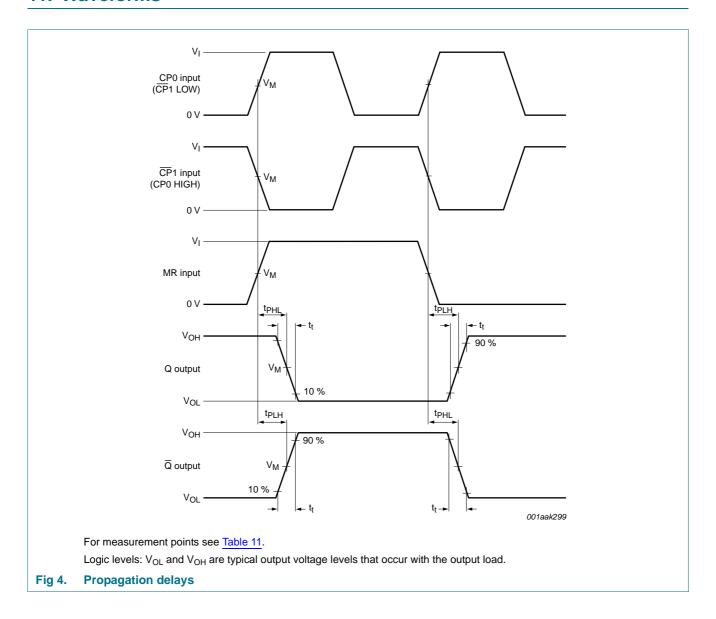
 P_D can be calculated from the formulas shown. $V_{SS} = 0 \text{ V}$; $t_r = t_f \le 20 \text{ ns}$; $T_{amb} = 25 \text{ °C}$.

| Symbol | Parameter | V_{DD} | Typical formula for P _D (μW) | where: |
|--------|------------------|----------|--|--|
| P_D | dynamic power | 5 V | $P_D = 3500 \times f_i + \Sigma (f_o \times C_L) \times V_{DD}^2$ | f _i = input frequency in MHz, |
| | dissipation 10 V | | $P_D = 15000 \times f_i + \Sigma (f_o \times C_L) \times V_{DD}^2$ | f _o = output frequency in MHz, |
| | | 15 V | $P_D = 37000 \times f_i + \Sigma (f_o \times C_L) \times V_{DD}^2$ | C_L = output load capacitance in pF, |
| | | | | V_{DD} = supply voltage in V, |
| | | | | $\Sigma(f_0 \times C_L)$ = sum of the outputs. |

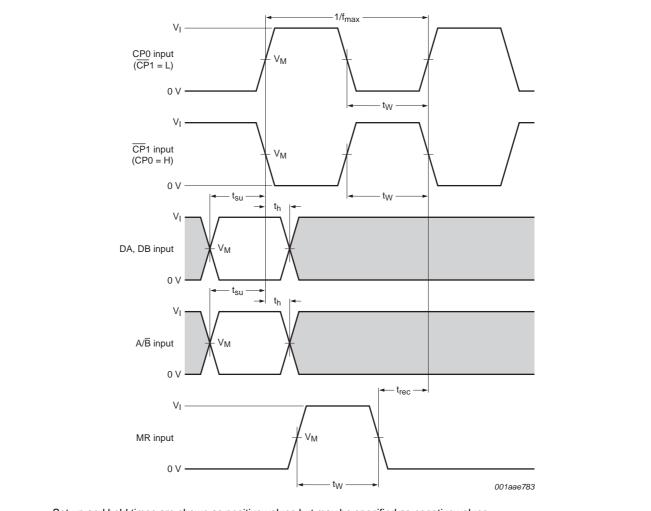
^[2] The set-up, hold, and recovery times vary with the minimum number of bits selected. For intermediate numbers not specified, interpolate as shown in Table 9.

1-to-64 bit variable length shift register

11. Waveforms



1-to-64 bit variable length shift register



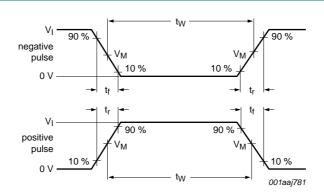
Set-up and hold times are shown as positive values but may be specified as negative values.

The shaded area indicates where data can change for predictable performance.

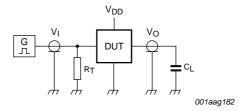
For measurement points see $\underline{\text{Table 11}}$.

Fig 5. Waveforms showing recovery time for MR and minimum CP0, CP1, and MR pulse widths, set-up and hold times for DA, DB, and A/B to CP0 and CP1

1-to-64 bit variable length shift register



a. Input waveforms



b. Test circuit

Test data is given in Table 11.

Definitions for test circuit:

Device Under Test (DUT)

C_L = Load capacitance including jig and probe capacitance;

 R_T = Termination resistance should be equal to output impedance Z_0 of the pulse generator.

Fig 6. Test circuit for switching times

Table 11. Measurement points and test data

| Supply voltage | Input | Load | | |
|----------------|----------------|-------------------|---------------------------------|-------|
| | V _I | V _M | t _r , t _f | CL |
| 5 V to 15 V | V_{DD} | 0.5V _I | ≤ 20 ns | 50 pF |

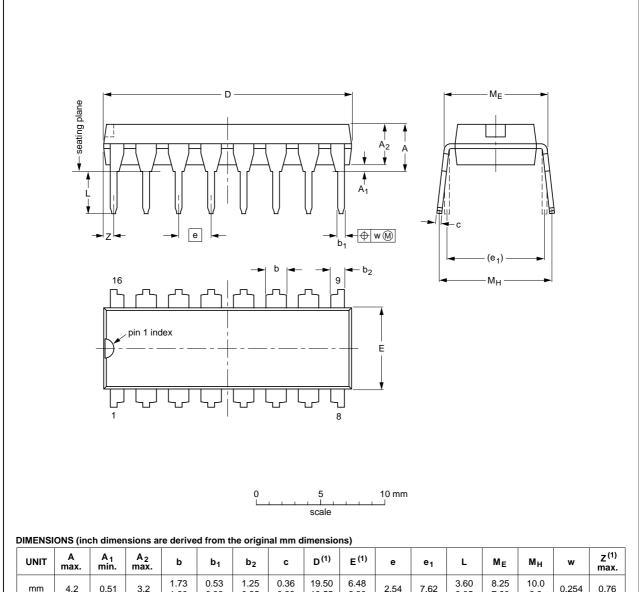
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1-to-64 bit variable length shift register

12. Package outline

DIP16: plastic dual in-line package; 16 leads (300 mil)

SOT38-4



| UNIT | A max. | A ₁ min. | A ₂ max. | b | b ₁ | b ₂ | С | D ⁽¹⁾ | E ⁽¹⁾ | е | e ₁ | L | ME | M _H | w | Z ⁽¹⁾ max. |
|--------|-----------|------------------------|------------------------|----------------|----------------|----------------|----------------|------------------|------------------|------|----------------|--------------|--------------|----------------|-------|--------------------------|
| mm | 4.2 | 0.51 | 3.2 | 1.73 1.30 | 0.53 0.38 | 1.25 0.85 | 0.36 0.23 | 19.50 18.55 | 6.48 6.20 | 2.54 | 7.62 | 3.60 3.05 | 8.25 7.80 | 10.0 8.3 | 0.254 | 0.76 |
| inches | 0.17 | 0.02 | 0.13 | 0.068 0.051 | 0.021 0.015 | 0.049 0.033 | 0.014 0.009 | 0.77 0.73 | 0.26 0.24 | 0.1 | 0.3 | 0.14 0.12 | 0.32 0.31 | 0.39 0.33 | 0.01 | 0.03 |

1. Plastic or metal protrusions of 0.25 mm (0.01 inch) maximum per side are not included.

| OUTLINE | | REFER | EUROPEAN | ISSUE DATE | | |
|---------|-----|-------|----------|------------|------------|---------------------------------|
| VERSION | IEC | JEDEC | JEITA | | PROJECTION | ISSUE DATE |
| SOT38-4 | | | | | | 95-01-14 03-02-13 |
| | | | | | | |

Fig 7. Package outline SOT38-4 (DIP16)

HEF4557B

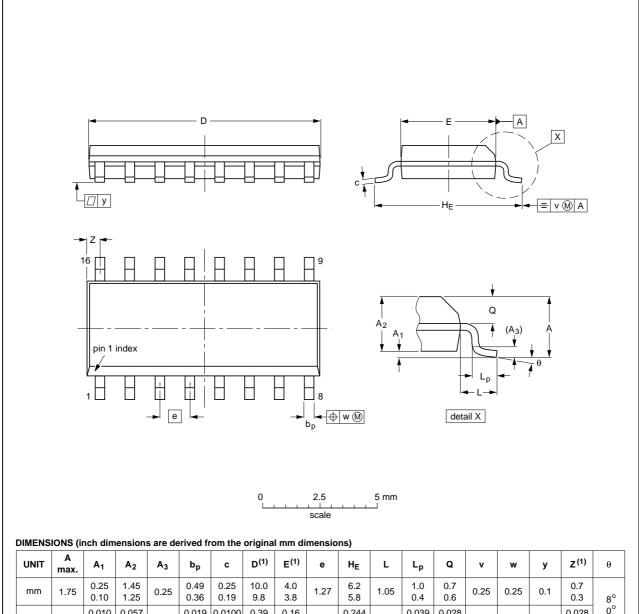
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HEF4557B NXP Semiconductors

SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1



| UNIT | A max. | A ₁ | A ₂ | A ₃ | bp | С | D ⁽¹⁾ | E ⁽¹⁾ | е | HE | L | Lp | Q | > | w | у | Z ⁽¹⁾ | θ |
|--------|-----------|----------------|----------------|----------------|--------------|------------------|------------------|------------------|------|----------------|-------|----------------|------------|------|------|-------|------------------|----|
| mm | 1.75 | 0.25 0.10 | 1.45 1.25 | 0.25 | 0.49 0.36 | 0.25 0.19 | 10.0 9.8 | 4.0 3.8 | 1.27 | 6.2 5.8 | 1.05 | 1.0 0.4 | 0.7 0.6 | 0.25 | 0.25 | 0.1 | 0.7 0.3 | 8° |
| inches | 0.069 | 0.010 0.004 | 0.057 0.049 | 0.01 | | 0.0100 0.0075 | 0.39 0.38 | 0.16 0.15 | 0.05 | 0.244 0.228 | 0.041 | 0.039 0.016 | | 0.01 | 0.01 | 0.004 | 0.028 0.012 | 0° |

Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

| OUTLINE | | REFER | EUROPEAN | ISSUE DATE | | |
|----------|--------|--------|----------|------------|------------|---------------------------------|
| VERSION | IEC | JEDEC | JEITA | | PROJECTION | 1330E DATE |
| SOT109-1 | 076E07 | MS-012 | | | | 99-12-27 03-02-19 |

Fig 8. Package outline SOT109-1 (SO16)

HEF4557B

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1-to-64 bit variable length shift register

13. Revision history

Table 12. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|------------------|--|--|---------------|------------------|
| HEF4557B v.6 | 20111118 | Product data sheet | - | HEF4557B v.5 |
| Modifications: | Section App | olications removed | | |
| | <u>Table 7</u>: I_{OF} | _I minimum values changed t | o maximum | |
| | • <u>Figure 5</u> : "A | \sqrt{B} input" changed to "A/ \overline{B} in | put" | |
| HEF4557B v.5 | 20091216 | Product data sheet | - | HEF4557B v.4 |
| HEF4557B v.4 | 20090916 | Product data sheet | - | HEF4557B_CNV v.3 |
| HEF4557B_CNV v.3 | 19950101 | Product specification | - | HEF4557B_CNV v.2 |
| HEF4557B_CNV v.2 | 19950101 | Product specification | - | - |
| | | | | |

1-to-64 bit variable length shift register

14. Legal information

14.1 Data sheet status

| Document status[1][2] | Product status[3] | Definition |
|--------------------------------|-------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

- [1] Please consult the most recently issued document before initiating or completing a design
- [2] The term 'short data sheet' is explained in section "Definitions".
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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15. Contact information

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16. Contents

| 1 | General description |
|------|----------------------------------|
| 2 | Features and benefits |
| 3 | Ordering information 1 |
| 4 | Functional diagram |
| 5 | Pinning information 3 |
| 5.1 | Pinning |
| 5.2 | Pin description |
| 6 | Functional description |
| 7 | Limiting values |
| 8 | Recommended operating conditions |
| 9 | Static characteristics |
| 10 | Dynamic characteristics |
| 11 | Waveforms |
| 12 | Package outline |
| 13 | Revision history |
| 14 | Legal information |
| 14.1 | Data sheet status |
| 14.2 | Definitions |
| 14.3 | Disclaimers |
| 14.4 | Trademarks16 |
| 15 | Contact information |
| 16 | Contento |

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